

Above- and Below-the-Rails Low On-Resistance Analog Switches

General Description

The MAX14759/MAX14761/MAX14763 analog switches are capable of passing bipolar signals that are beyond their supply rails. These devices operate from a single +3.0V to +5.5V supply and support signals in the -25V to +25V range.

The MAX14759 is a single-pole/single-throw (SPST) analog switch, while the MAX14761 is a dual-SPST analog switch. The MAX14763 is a single-pole/double-throw (SPDT) analog switch.

The MAX14759 features 1 Ω (max) on-resistance with a ±200nA (max) on-leakage current. The MAX14761/ MAX14763 feature 2 Ω (max) on-resistance with a ±100nA (max) on-leakage current. The low on-resistance and high bandwidth allow use in digital- and analog-signal switching applications.

The MAX14759/MAX14763 are available in an 8-pin (3mm x 3mm) TDFN package. The MAX14761 is available in a 10-pin (3mm x 3mm) TDFN package. These devices are specified over the -40°C to +85°C extended temperature range.

<u>Ordering Information/Selector Guide</u> appears at end of data sheet.

For related parts and recommended products to use with this part, refer to **www.maximintegrated.com/MAX14759.related**.

Benefits and Features

- High Performance
 - \diamond Low 1 Ω (max) or 2 Ω (max) On-Resistance
 - \diamond Low 2.4m Ω (typ) and 5.1m Ω (typ) R_{ON} Flatness
 - ♦ 500mA (max) Switch Current for MAX14759
 - Thermal Shutdown Protection

 - High Bandwidth: 100MHz (typ) Insertion Loss
 - ♦ High-ESD Protection Up to 2kV

Save Board Space

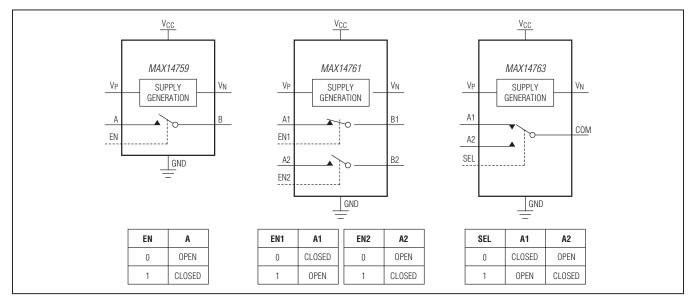
Small 8-Pin and 10-Pin TDFN Packages

Applications

- Industrial Measurement Systems Instrumentation Systems RS-485 Termination Switching CAN Bus Termination Switching Opto-Relay Replacement Medical Systems
- ATE Systems

Audio Signal Routing and Switching

Functional Diagrams/Truth Tables



For pricing, delivery, and ordering information, please contact Maxim Direct at 1-888-629-4642, or visit Maxim's website at www.maximintegrated.com.

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ABSOLUTE MAXIMUM RATINGS

(All voltages referenced to GND, unless otherwise noted.)	Continuous Current Through Switch
V _{CC} 0.3V to +6V	(MAX14761, MAX14763)±250mA
EN, EN1, EN2, SEL0.3V to + (V _{CC} + 0.3V)	Continuous Power Dissipation (T _A = +70°C)
A, B, A1, A2, B1, B2, COM(V _N - 0.3V) to Lesser of	8-Pin TDFN Package
$(V_{P} + 0.3V)$ or $(V_{N} + 52V)$	(derate 24.4mW/°C above +70°C)1951.2mW
V _P 0.3V to Lesser of	10-Pin TDFN Package
(+52V) or (V _N + 70V)	(derate 24.4mW/°C above +70°C)1951.2mW
V _N Greater of (V _{CC} - 40V) or (V _P - 70V) to +0.3V	Operating Temperature Range40°C to +85°C
V _P to V _N 0.3V to +0.5V Continuous Current Through Switch (MAX14759)±500mA	Storage Temperature Range65°C to +160°C Lead Temperature (soldering, 10s)+300°C Soldering Temperature (reflow)+260°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

PACKAGE THERMAL CHARACTERISTICS (Note 1)

8-Pin TDFN

 10-Pin TDFN

Note 1: Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to <u>www.maximintegrated.com/thermal-tutorial</u>.

ELECTRICAL CHARACTERISTICS

 $(V_{CC} = +3.0V \text{ to } +5.5V, T_A = -40^{\circ}C \text{ to } +85^{\circ}C, \text{ unless otherwise noted. Typical values are at } V_{CC} = 5V \text{ and } T_A = +25^{\circ}C.)$ (Note 2)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS	
DC CHARACTERISTICS								
Power Supply Range	V _{CC}			3.0		5.5	V	
Continuous Current Through		(MAX14759)	(MAX14759)			+500		
Switch	I _A _	(MAX14761/MAX1-	4763)	-250		+250	mA	
			$V_{EN_{-}} = V_{CC}$		4.1	10		
Supply Current		$V_{CC} \le 4.7V$	$V_{EN_{}} = V_{CC}/2$		4.1	10		
Supply Current	Icc		$V_{EN_{}} = V_{CC}$		2.5	6	- mA -	
		$V_{\rm CC} > 4.7V$	$V_{EN_{}} = V_{CC}/2$		2.5	6		
Analog-Signal Range	V _{COM} , V _A _, V _B _	Switch open or closed		-25		+25	V	
On-Resistance		$I_{B} = \pm 500 \text{mA}, V_{A} = \pm 25 \text{V} (\text{MAX14759})$			0.6	1	Ω	
	R _{ON}	I_{COM} or $I_{B_}$ = ±250mA, $V_{A_}$ = ±25V (MAX14761/MAX14763)			1.2	2		
		$-25V < V_A < +25V, I_B = \pm 500$ mA (MAX14759)			2.4			
On-Resistance Flatness	ΔR_{ON}	$-25V < V_{A_{-}} < +25V, I_{B_{-}} \text{ or } I_{COM} = \pm 250 \text{mA}$ (MAX14761/MAX14763)			5.1		mΩ	
		$V_A = +25V, V_B = 0V,$ Figure 1 (MAX14759)		-250		+250		
A, A1, A2 Off-Leakage Current	I _{A_(OFF)}	V _A _ = +25V, V _{COM} or V _B _= 0V, Figure 1 (MAX14761/MAX14763)		-250		+250	nA	
COM, B, B1, B2 Off-Leakage	ICOM(OFF),	V _{COM} or V _B = 15V, V _A = 0V, Figure 1 (MAX14759/MAX14763)		-100		+100	nA	
Current	^I B_(OFF)	$V_{B_{-}} = 15V, V_{A_{-}} = 0$	0V, Figure 1 (MAX14761)	-100		+100	00	

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ELECTRICAL CHARACTERISTICS (continued) (V_{CC} = +3.0V to +5.5V, T_A = -40°C to +85°C, unless otherwise noted. Typical values are at V_{CC} = 5V and T_A = +25°C.) (Note 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	ТҮР	MAX	UNITS	
		$V_A = \pm 25V$, B1, B2, or COM are unconnected, Figure 1 (MAX14759)	-200		+200		
On-Leakage Current	I _{ON}	$V_A = \pm 25V, B1, B2, or COM are unconnected, Figure 1 (MAX14761)$	-100		+100	0 nA	
		$V_A = \pm 25V$, B1, B2, or COM are unconnected, Figure 1 (MAX14763)	-250		+250		
DIGITAL LOGIC							
		$V_{CC} = 3.0V$			0.7		
Input Voltage Low	Ma	$V_{CC} = 3.6V$			0.7		
Input-Voltage Low	VIL	$V_{CC} = 4.5V$			0.8		
		$V_{CC} = 5.5V$			0.8	1	
		$V_{CC} = 3.0V$	1.7			,	
		$V_{\rm CC} = 3.6 V$	1.9				
Input-Voltage High	V_{IH}	$V_{\rm CC} = 4.5 V$	2.0			V	
		$V_{CC} = 5.5V$	2.1			1	
Input Current	١L		-1		+1	μA	
AC CHARACTERISTICS		· · · · · ·					
Power-On Time	t _{PWRON}	$C_{VP} = C_{VN} = 100$ nF (Note 3)		50		ms	
Enable Turn-On Time	t _{ON}	$V_{A_{-}} = \pm 10V$, $R_{L} = 10k\Omega$, Figure 2 (MAX14759/MAX14761)		152	300	μs	
		$V_{A_{-}} = \pm 10V, R_{L} = 10k\Omega$, Figure 2 (MAX14763)		1.12	1.8	ms	
Enable Turn-Off Time	t _{OFF}	$V_{A_{\perp}} = \pm 10V, R_{\perp} = 10k\Omega$, Figure 2		300	1000	μs	
Break-Before-Make Interval	t _{BBM}	$V_{A_{-}} = 1V_{RMS}, R_{L} = 10k\Omega$, Figure 3 (MAX14763)		740		μs	
Off-Isolation	V _{ISO}	$V_{A_{\perp}} = 1V_{RMS}$, f = 100kHz, R _L = 50 Ω , C _L = 15pF, Figure 4		-77		dB	
Crosstalk	V _{CT}	$\label{eq:RS} \begin{array}{l} R_{S} = R_{L} = 50 \Omega, \ f = 100 kHz, \ V_{COM} = 1 V_{RMS}, \\ \mbox{Figure 5 (MAX14763)} \end{array}$		-83		dB	
-3dB Bandwidth	BW	$R_S=50\Omega,R_L=50\Omega$, $V_{A}=1V_{P\text{-}P},Figure\;6$		100		MHz	
Total Harmonic Distortion Plus Noise	THD+N	$R_{S} = R_{L} = 1k\Omega$, f = 20Hz to 20kHz		0.0012		%	
Charge Injection	Q	$V_{A_{-}} = GND, C_{L} = 1nF, Figure 7$		1370		рС	
Input Capacitance	C _{IN}	At A, A1, A2, B, B1, B2, and COM pins		58		рF	
THERMAL PROTECTION		· · · · · · · · · · · · · · · · · · ·					
Thermal Shutdown Temperature	t _{HYST}			+154		°C	
Shutdown Temperature Hysteresis	t _{SHUT}			24		°C	
ESD PROTECTION							
All Pins		Human Body Model		±2		kV	

Note 2: All devices are 100% production tested at $T_A = +25$ °C. Specifications over operating temperature range are guaranteed by design.

Note 3: The power-on time is defined as the settling time for the charge pump's output to reach steady-state value within 1%.

Test Circuits/Timing Diagrams

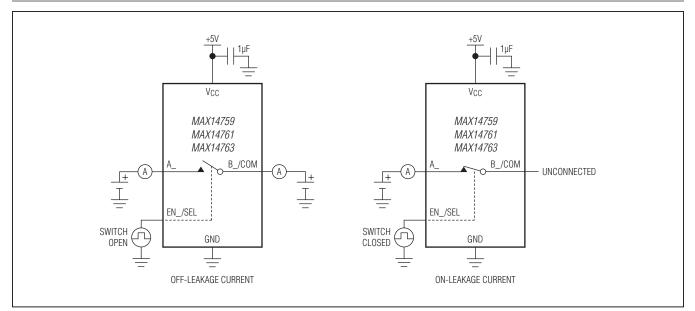


Figure 1. Leakage Current Measurement

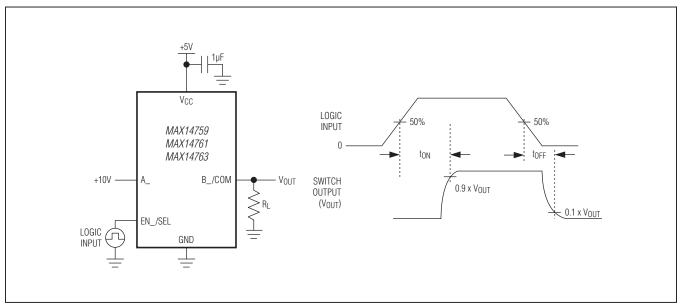


Figure 2. Switching Time

Test Circuits/Timing Diagrams (continued)

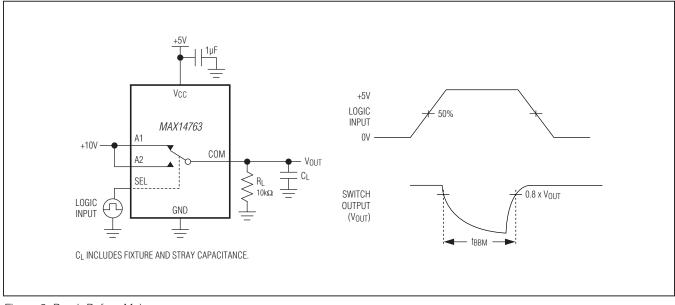


Figure 3. Break-Before-Make

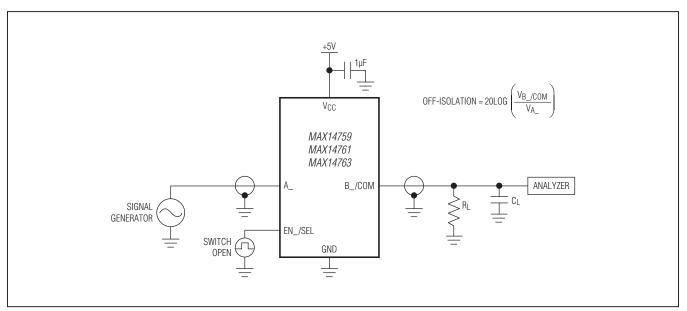


Figure 4. Off-Isolation

Test Circuits/Timing Diagrams (continued)

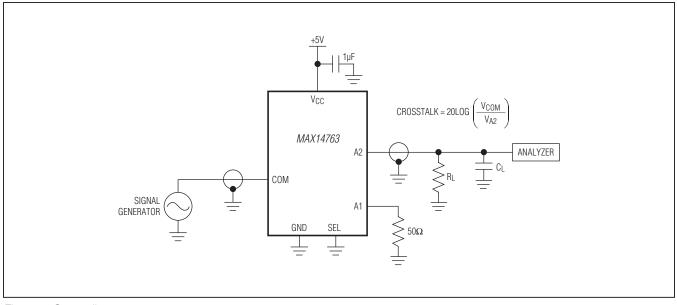


Figure 5. Crosstalk

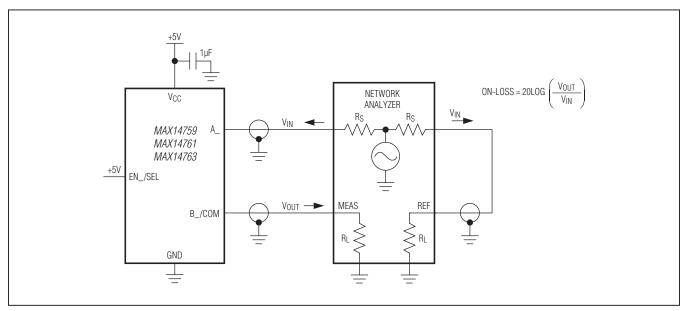


Figure 6. Insertion Loss

Test Circuits/Timing Diagrams (continued)

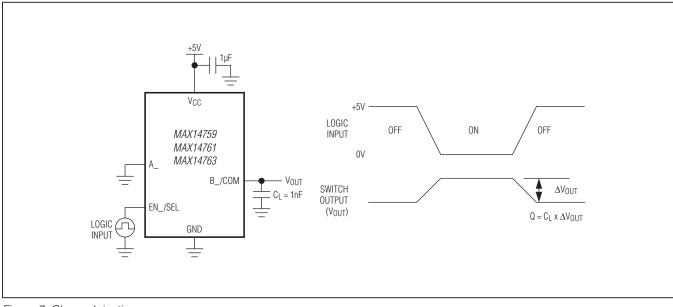
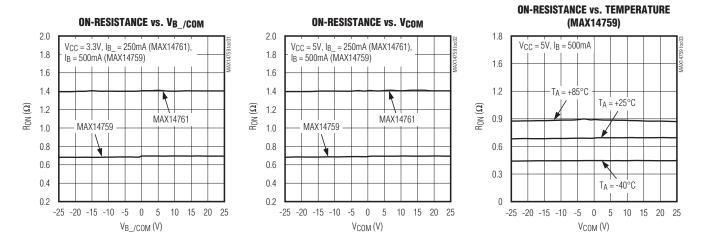
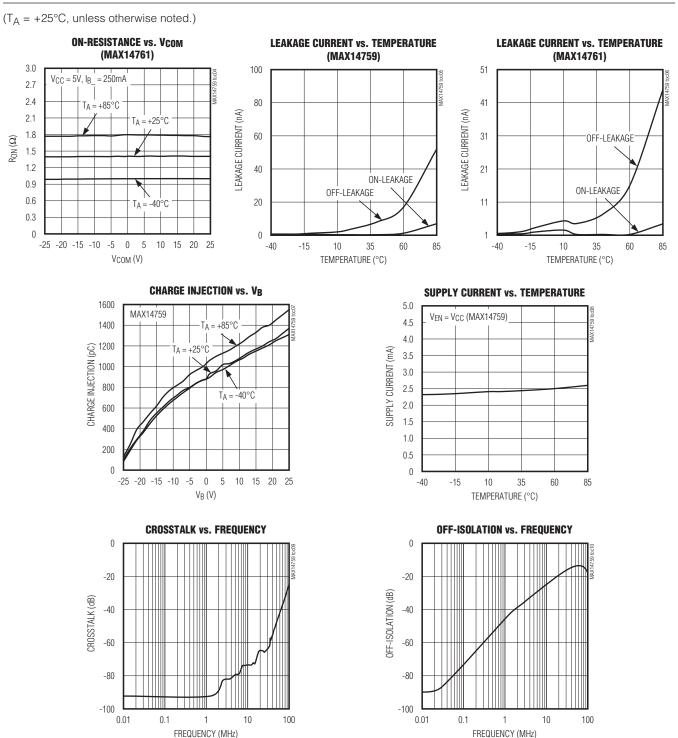


Figure 7. Charge Injection



 $(T_A = +25^{\circ}C, unless otherwise noted.)$

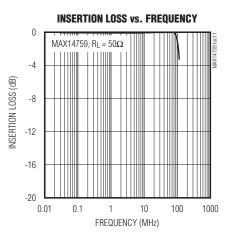


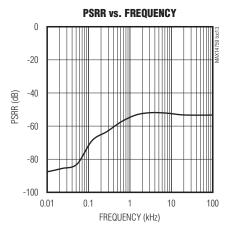


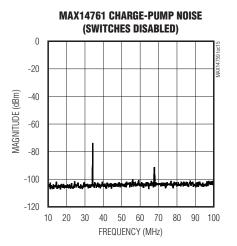
Typical Operating Characteristics (continued)

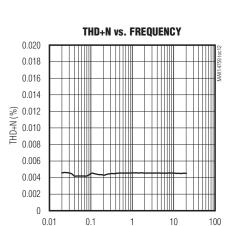
Typical Operating Characteristics (continued)

 $(T_A = +25^{\circ}C, \text{ unless otherwise noted.})$



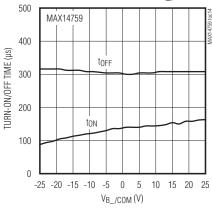




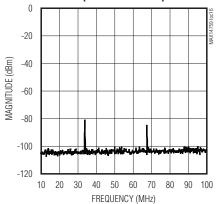


TURN-ON/OFF TIME vs. VB /COM

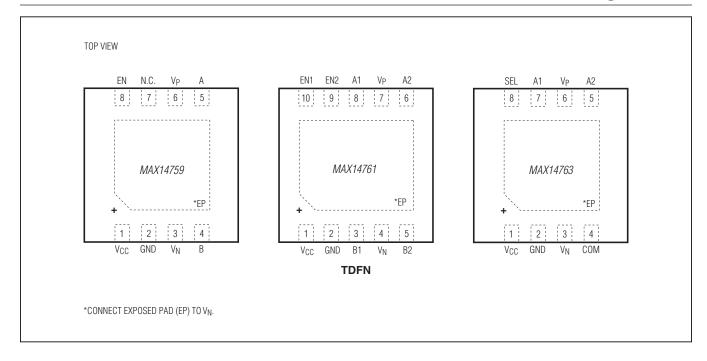
FREQUENCY (kHz)



MAX14761 CHARGE-PUMP NOISE (SWITCH ENABLED)



Pin Configurations



Pin Description

	PIN			FUNCTION	
MAX14759	MAX14761	MAX14763	NAME	FUNCTION	
1	1	1	V _{CC}	Positive-Supply Voltage Input. Bypass V_{CC} to GND with a 1µF ceramic capacitor placed as close as possible to the device.	
2	2	2	GND	Ground	
3	4	3	V _N	Negative Voltage Output. Bypass V_N to GND with a 0.1µF, 50V ceramic capacitor placed as close as possible to the device.	
4	_	_	В	Analog Switch Common Terminal	
	_	4	COM	Analog Switch Common Terminal	
5	—	—	А	Analog Switch Normally Open Terminal	
6	7	6	VP	Positive Voltage Output. Bypass V_P to GND with a 0.1µF, 50V ceramic capacitor placed as close as possible to the device.	
7			N.C.	No Connection. Leave unconnected.	
8			EN	Switch Control Input. Drive EN high to close the switch or drive EN low to open the switch.	
	8	7	A1	Analog Switch 1 Normally Closed Terminal	

	PIN		NAME	FUNCTION	
MAX14759	MAX14761	MAX14763	NAME	FUNCTION	
—	3		B1	Analog Switch 1 Common Terminal	
—	6	5	A2	Analog Switch 2 Normally Open Terminal	
_	5		B2	Analog Switch 2 Common Terminal	
_	10	_	EN1	Switch 1 Control Input. Drive EN1 high to open switch 1 or drive EN1 low to close switch 1.	
_	9	_	EN2	Switch 2 Control Input. Drive EN2 high to close switch 2 or drive EN2 low to open switch 2.	
_	_	8	SEL	Switch Control Input. Drive SEL low to connect the COM terminal to A1 or drive SEL high to connect the COM terminal to A2.	
	_		EP	Exposed Pad. Connect EP to $V_{N}.$ EP is not intended as an electrical connection.	

Pin Description (continued)

Detailed Description

The MAX14759/MAX14761/MAX14763 are analog switches capable of handling signals above and below their rails. These devices operate from a single +3.0V to +5.5V supply and support signals in the -25V to +25V range. The low on-resistance and high bandwidth allow for use in digital- and analog-signal switching applications.

Integrated Bias Generation

The MAX14759/MAX14761/MAX14763 contain a total of three charge pumps to generate bias voltages for the internal switches: a 5V regulated charge pump, a positive high-voltage (+35V) charge pump, and a negative high-voltage (-27V) charge pump. When V_{DD} is above 4.7V (typ), the 5V regulated charge pump is bypassed, and V_{DD} provides the input for the high-voltage charge pumps, reducing overall supply current. An external 0.1 μ F capacitor is required for each high-voltage charge pump between V_P/V_N and GND.

Analog Signal Range

The devices switch signals in the range from -25V to +25V that are above and below their rails. The on-resistance for these devices exhibit a high degree of flatness of 2.4m Ω (MAX14759 typ) and 5.1m Ω (MAX14761/MAX14763 typ) over the whole input voltage range of -25V to +25V. The analog switches allow bidirectional current flow, so A, A1,

A2, B, B1, B2, and COM can be used as either inputs or outputs.

Bypass Capacitors

Bias stabilizing capacitors are required on the V_P and V_N pins. 1 μ F ceramic capacitors are suggested for effective operation. V_P and V_N are not intended as a power supply for other circuitry.

Applications Information

Nonpowered Condition

The MAX14759/MAX14761/MAX14763 can tolerate input voltages on the A, B, or COM pins in the $\pm 25V$ range when it is not powered. When $V_{DD} = 0V$, the DC input leakage current into the A, B, or COM pins is typically below 1µA. Some devices can have a larger leakage current up to the mA range due to technology spread.

With V_{DD} not powered, internal diodes between the analog pins and the V_P and V_N charge up the external capacitors on V_P and V_N when positive and/or negative voltages are applied to these pins. This causes transient input current flow.

Large dv/dt on the inputs causes large capacitive charging currents, which have to be limited to 300mA to avoid destroying the internal diodes. Hence, the 100nF capacitors on V_P and V_N, the dv/dt must be limited to 3V/µs. Once the capacitors reach their final voltage, the input current decays to the leakage current levels mentioned above.

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Differential Termination Resistor Switch

The MAX14759 can be used to switch a differential termination resistor in or out. In RS-485 and CAN applications, both ends of high-speed transmission lines require termination. Figures 8 and 9 show an application of RS-485 and CAN termination using two equal resistors. These switches support RS-485's high -7V to +12V commonmode range.

In RS-232/RS-485 multiprotocol applications, the MAX14759 can be used for switching in the line-terminating resistors for RS-485 usage, and can disable the termination resistor for RS-232 operation, as shown in Figure 10.

The MAX14761 is ideal for switching in fail-safe biasing resistors in RS-485 applications, as shown in <u>Figures 11</u> and 12.

Audio Amplifier Switch

The MAX14763 is used for selecting between audio amplifier sources to drive loudspeaker applications (Figures 13 and 14.)

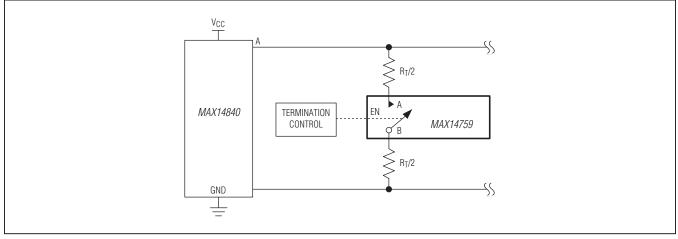


Figure 8. RS-485 Termination Switch

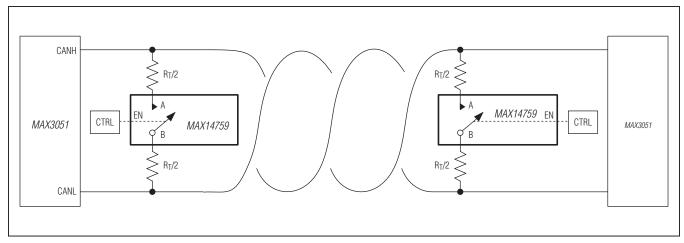


Figure 9. CAN Termination Switch

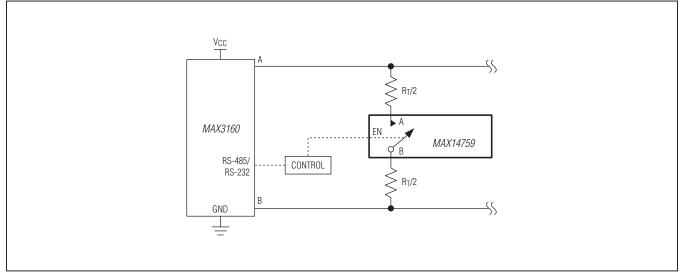


Figure 10. Multiprotocol Termination Switch

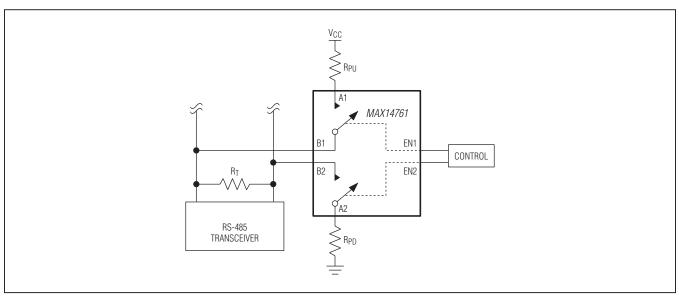


Figure 11. Pullup and Pulldown Resistance Switch

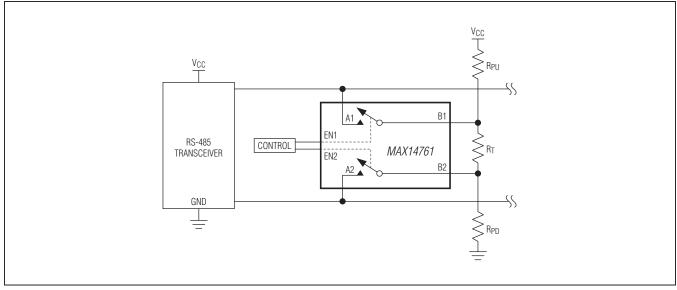


Figure 12. Fail-Safe Biasing Network Switch

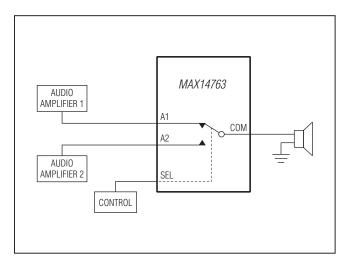


Figure 13. Single-Ended Amplifier Switching

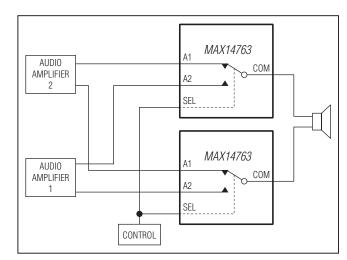


Figure 14. Differential Amplifier Switching

Ordering Information/Selector Guide

PART	TEMP RANGE	PIN-PACKAGE	FUNCTION	R _{ON} (MAX) (Ω)
MAX14759ETA+	-40°C to +85°C	8 TDFN-EP*	1 x SPST	1
MAX14761ETB+	-40°C to +85°C	10 TDFN-EP*	2 x SPST	2
MAX14763ETA+	-40°C to +85°C	8 TDFN-EP*	1 x SPDT	2

+Denotes a lead(Pb)-free/RoHS-compliant package.

*EP = Exposed pad.

Chip Information

PROCESS: BICMOS

Package Information

For the latest package outline information and land patterns (footprints), go to <u>www.maximintegrated.com/packages</u>. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE TYPE	PACKAGE CODE	OUTLINE NO.	LAND PATTERN NO.
8 TDFN	T833+2	<u>21-0137</u>	<u>90-0059</u>
10 TDFN	T1033+1	<u>21-0137</u>	<u>90-0003</u>

Revision History

16

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	9/11	Initial release	—
1	8/12	Updated <i>Electrical Characteristics</i> table, updated Figures 1–7, added Switch Enabled and Switch Disabled figures, updated <i>Pin Configuration</i> table, added <i>Integrated Bias Generation</i> and <i>Nonpowered Condition</i> sections	3–7, 9–11



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